EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3	10/733807	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 13:44
S6	5600	semitool perkins adj coie	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 15:32
S7	563	S6 and (cabinet module platform) and (stations! cells!)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 15:33
S11	61	S8 and brac$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 16:13
S10	10	S8 and bracing	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 16:13
S12	10	S6 and (housing) and (stations! cells!) and bracing	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 16:21
S14	18	("20010050060" | "20020017237" | "20020112738" | "20030176067" | "20040129302" | "4998050" | "5353490" | "5479252" | "5544421" | "5733024" | "6267853" | "6309520" | "6312525" | "6334937" | "6423642" | "6548411" | "6660098" | "6695914").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/01/18 16:22

S13	2	S9 and bracing	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 16:22
S9	10	10/202074	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 16:22
S5	55	("20010052465"|"20020000380"|"20020088708"|"20030221953"|"20050000817"|"20050006241"|"3652442"|"4648774"|"5284554"|"5312532"|"5344491"|"5421987"|"5431421"|"5476577"|"5486282"|"5516421"|"5536388"|"5543032"|"5567300"|"5683564"|"5865984"|"5925226"|"6001235"|"6103096"|"6168695"|"6181057"|"6228231"|"6251250"|"6379511"|"6454918"|"6482300"|"6547937"|"6635157"|"6660137"|"6672820").PN. ("20010032788"|"4749601"|"6136163"|"6214193"|"6231743").PN. ("5000827"|"5222310"|"5230743"|"5344539"|"5531874"|"5614076"|"5635157"|"5762751"|"6024856"|"6037790"|"6048154"|"6082948"|"6132586"|"6197182"|"6328872").PN.	US-PGPUB; USPAT	OR	ON	2007/01/18 16:27
S15	8	("6027631" "6251250" "20010032788" "6454918" "6875333" "5516412" "6955747" "6214193").pn.	US-PGPUB; USPAT	OR	ON	2007/01/18 16:31
S17	14	S6 and (cabinet module platform deck housing) and (stations! cells! chambers!) and bracing	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 16:34
S8	583	S6 and (cabinet module platform deck) and (stations! cells!)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:29

EAST Search History

S18	166	S8 and (bolts fasten$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:30
S19	109	S8 and (cabinet module platform deck housing) same (bolts fasten screws)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:42
S20	54	S8 and (cabinet module platform deck housing) same (bolts fasten screws) same (station cell chamber)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:55
S21	1450	(applied adj materials) and ("204" "205").clas.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:56
S16	17	S6 and (cabinet module platform deck housing) and (stations! cells! chambers) and bracing	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:57
S22	424	S21 and (cabinet module platform deck housing mainframe) and (stations! cells! chambers!)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 17:58
S4	2	10/734098 10/734100	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 18:08
S24	57	S23 and (magnet same processing adj (site surface) magnet with (wafer workpiece microelectronics micropiece))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 18:17
S26	1	2001-581416.NRAN.	DERWENT	OR	ON	2007/01/18 18:18

EAST Search History

S25	1	WO with "200150505"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 18:18
S23	228	electroplating and magnet and ("204" "205").clas. and (wafer semiconductor microelectronics microfeature workpiece)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 18:26
S28	14	electroplating and ("204" "205"). clas. and (wafer semiconductor microelectronics microfeature workpiece) and paddles! same agitat$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 18:27
S27	58	electroplating and ("204" "205"). clas. and (wafer semiconductor microelectronics microfeature workpiece) and paddle same agitat$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/18 18:27
S29	616	pins! same (holes! recepticle openings!) same (position$4 align$4) and ("204" "205").clas.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:05
S32	2	"4493757".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:11
S31	71	S30 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:11
S30	9303	pins! same (holes! recepticle openings!) same (position$4 align$4) same precis$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:20

S34	186	pins! same (holes! recepticle openings!) same (position$4 align$4) with precis$3 same bolts! with secur$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:21
S33	4875	pins! same (holes! recepticle openings!) same (position$4 align$4) with precis$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:21
S36	171	joist with top with panel same bottom with panel	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:32
S35	1382693	joist with top with panel same bottom panel	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 11:32
S37	2	"6238494".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 15:20
S38	3	"6331233".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/19 15:21